





Board Stack Report

Stack Up			Layer Stack			
Layer	Board Layer Stack	Board Layer Stack	Name	Material	Thickness	Constant
1			Top Paste			
2			Top Overlay			
3			Top Solder	Solder Resist	0.40mil	3.5
4			Top Layer	Copper	1.40mil	
5			Dielectric 1	FR-4	12.60mil	4.8
6			Bottom Layer	Copper	1.40mil	
7			Bottom Solder	Solder Resist	0.40mil	3.5
8			Bottom Overlay			
9			Bottom Paste			
	Height : 16.20mil	Height : 16.20mil				